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(AN/"ECI Technology" AND AC/"Totowa"): 13 patents.
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	PAT. NO.	Title
1	10,920,336	Analysis of silver ion and complexing agent in tin-silver electrodeposition solution
2	10,590,560	Control of additive turnover in an electrodeposition solution
3	10,407,795	Analysis of silver ion and complexing agent in tin-silver electrodeposition solution
4	9,593,931	Palladium coating thickness measurement
5	9,274,079	Etchant product analysis in alkaline etchant solutions
6	8,535,504	Analysis of an auxiliary leveler additive in an acid copper plating bath
7	8,142,640	Chloride analysis in acid copper plating baths
8	8,118,988	Analysis of copper ion and complexing agent in copper plating baths
9	8,008,087	Analysis of silicon concentration in phosphoric acid etchant solutions
10	7,932,094	Method and apparatus for determining the stability of an electroless plating bath
11	7,879,222	Detection of additive breakdown products in acid copper plating baths
12	7,351,349	Method and apparatus for real-time dynamic chemical analysis
13	7,291,253	Detection of an unstable additive breakdown product in a plating bath